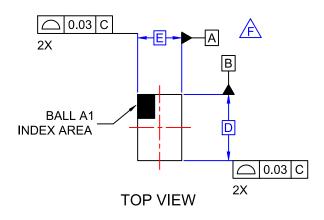
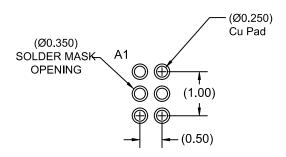


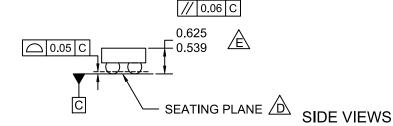
## WLCSP6 1.46x0.96x0.582 CASE 567RM ISSUE O

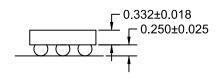
**DATE 30 NOV 2016** 

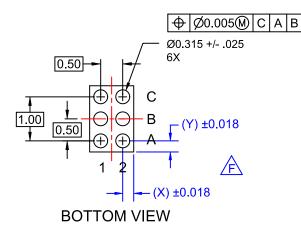




RECOMMENDED LAND PATTERN (NSMD PAD TYPE)







## NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

DESCRIPTION:	WLCSP6 1.46x0.96x0.582	PAGE 1 OF 1
DESCRIPTION.	WECGFO 1.40X0.90X0.302	PAGETOFT

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